

Patent

Customer No.: 31561
Docket No.: 13063-US-PA
Application No.: 10/710,843

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of

Applicants/ Petitioners : Lin et al.
Application No. : 10/710,843
For : A METHOD OF MANUFACTURING
SEMICONDUCTOR LASER DEVICE
STRUCTURE
Notice of Allowance Mailed : November 30, 2007
Art Unit : 2823
Examiner : LEE, JAE

**RENEWED PETITION TO WITHDRAW HOLDING OF ABANDONMENT
AND REVIVE APPLICATION UNDER 37 CFR 1.181**

(Total Pages: 2+1)

U.S. Patent and Trademark Office

ATTN: Office of Petitions

Customer Service Window

Mail Stop **Petition**

Randolph Building

401 Dulany Street

Alexandria, VA 22314

Dear Sir,

In response to the dismissed Decision of Petition mailed on June 20, 2008, Applicants/Petitioners hereby request for reconsideration of the said decision by submitting this request accompanying with the follows.

1. Issue Fee Transmittal (PTOL-85B) in 1 page.

Assignee which Applicants/Petitioners have assigned their interests of the above-referenced application to is entitled to a status as **Small Entity**. The commissioner is authorized to charge the following required fees and any fees required in connection with filing this paper to Deposit Account **50-2620** (Order No. 13063-US-PA).

1. Petition Fee under 37 CFR 1.17(m) for Petition to revive unintentionally abandoned application in an amount of USD\$ 770.

2. Utility Issue Fee of USD\$ 720 and Publication fee of USD\$ 300 under 37 CFR 1.18(a) and 1.18(d).

Thank you for your attention and assistance in this regard. Should you need any further information, please feel free to contact the undersigned.

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Respectfully Submitted,
JIANQ CHYUN Intellectual Property Office

Date: July 17, 2008

By: Belinda Lee
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